503530077 10/20/2015 PATENT ASSIGNMENT COVER SHEET

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		NEW ASSIGNMENT	
NATURE OF CONVEYANCE:		ASSIGNMENT	
ONVEYING PARTY DA	ТА		
		Name	Execution Da
CHIAMING CHAI			10/12/2015
SHAOPING GE			10/12/2015
STEPHEN EDWARD LILES			10/13/2015
HINTAN HEMENDRAK	JMAR SHA	Н	10/13/2015
ECEIVING PARTY DAT	`A		
Name: QUALCOMM INCORPORATED			
treet Address:	5775 MOREHOUSE DRIVE		
ity:	SAN DIEGO		
tate/Country:	CALIFORNIA		
ostal Code:	92121		
ROPERTY NUMBERS	Fotal: 1		-
Property Type		Number	
Application Number:		27125	
	<i>sent to the</i> rovided; if a 919 dsm W& ² 2530	e e-mail address first; if that is un that is unsuccessful, it will be ser -238-2300 hith@wt-ip.com T/QUALCOMM 0 MERIDIAN PARKWAY TE 300 RHAM, NORTH CAROLINA 27713	
orrespondent Name: ddress Line 1: ddress Line 2: ddress Line 4:			
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orrespondent Name:		TE 300	

PATENT REEL: 036830 FRAME: 0295

ASSIGNMENT

WHEREAS, WE,

1. Chiaming Chai, a citizen of the United States, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121 and a resident of Cary, North Carolina,

2. Shaoping Ge, a citizen of the United States, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121 and a resident of Cary, North Carolina,

3. Stephen Edward Liles, a citizen of the United States, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121 and a resident of Apex, North Carolina,

4. Chintan Hemendrakamar Shah, a citizen of the United States, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121 and a resident of Apex, North Carolina,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to DYNAMIC VOLTAGE LEVEL SHIFTERS EMPLOYING PULSE GENERATION CIRCUITS, AND RELATED SYSTEMS AND METHODS (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/827,125 filed August 14, 2015, Qualcomm Reference No. 147520, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

PATENT REEL: 036830 FRAME: 0296 AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at <u>RTP</u>, NC, on <u>10/12/15</u> LOCATION DATE

RNC, on 19/12/15 Done at hales

Chiaming Chai

Shaoping Ge

Done at <u>Releich NC</u>, on <u>10/13/15</u> <u>Stephen Edward Liles</u>

Done at Raleich NC, on 10/13/15

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